

CL70R380F

700V N-Channel Super Junction MOSFET

Features

- Very Low FOM ($R_{DS(on)} \times Q_g$)
- Extremely low switching loss
- Excellent stability and uniformity
- 100% Avalanche Tested
- Built-in ESD Diode

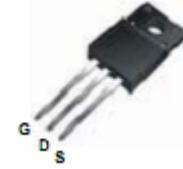
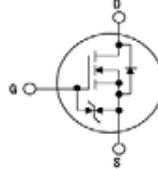
Applications

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)
- TV power & LED Lighting Power
- AC to DC Converters
- Telecom

Key Parameters

Parameter	Value	Unit
BV_{DSS}	700	V
I_D	11	A
$R_{DS(on),max}$	0.38	Ω
$Q_{g,Typ}$	25	nC

Package & Internal Circuit

TO-220F	SYMBOL
	

Absolute Maximum Ratings $T_C=25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	Value	Unit
V_{DSS}	Drain-Source Voltage	700	V
V_{GS}	Gate-Source Voltage	± 30	V
I_D	Drain Current - Continuous ($T_C = 25^\circ\text{C}$)	11	A
	Drain Current - Continuous ($T_C = 100^\circ\text{C}$)	6.9	A
$I_{DM}^{(1)}$	Drain Current - Pulsed	33	A
$E_{AS}^{(2)}$	Single Pulsed Avalanche Energy	151	mJ
I_{AR}	Avalanche Current	1.75	A
dv/dt	MOSFET dv/dt ruggedness, $V_{DS}=0\dots 400\text{V}$	50	V/ns
dv/dt	Reverse diode dv/dt , $V_{DS}=0\dots 400\text{V}$, $IDS \leq ID$	15	V/ns
P_D	Power Dissipation ($T_C = 25^\circ\text{C}$)	33	W
$V_{ESD(G-S)}$	Gate source ESD(HBM-C=100pF, $R=1.5\text{K}\Omega$)	2500	V
T_j , T_{stg}	Operating and Storage Temperature Range	-55 to +150	°C

Thermal Resistance Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	3.79	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W



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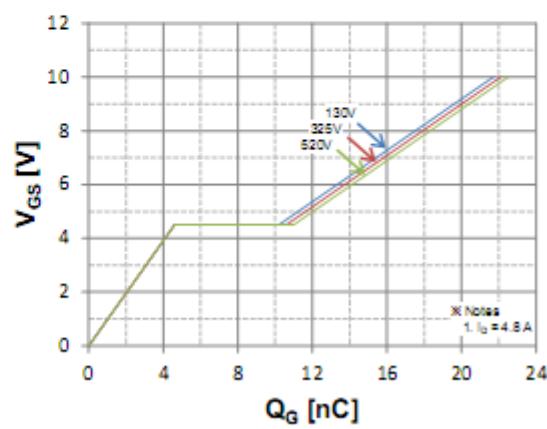
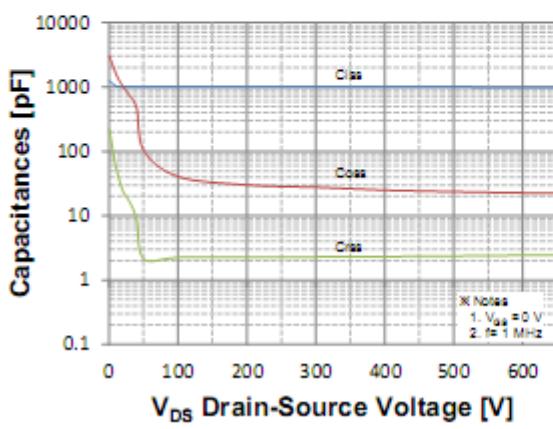
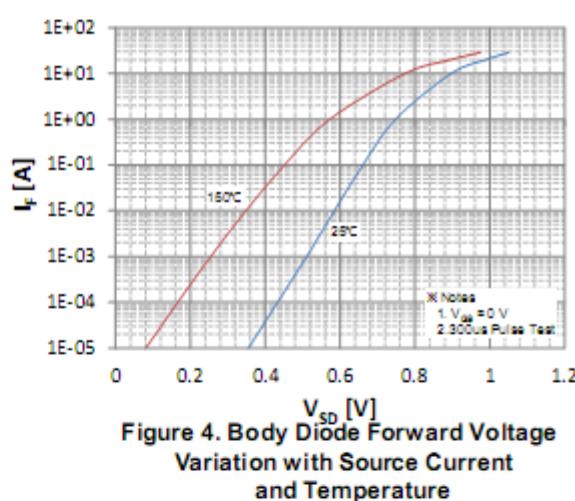
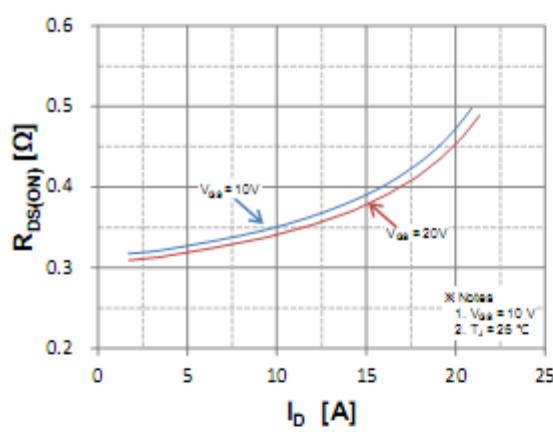
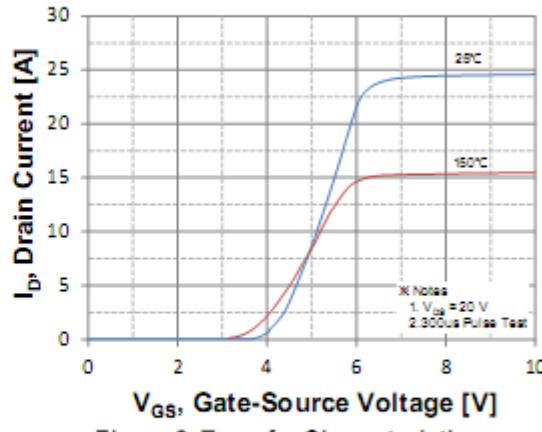
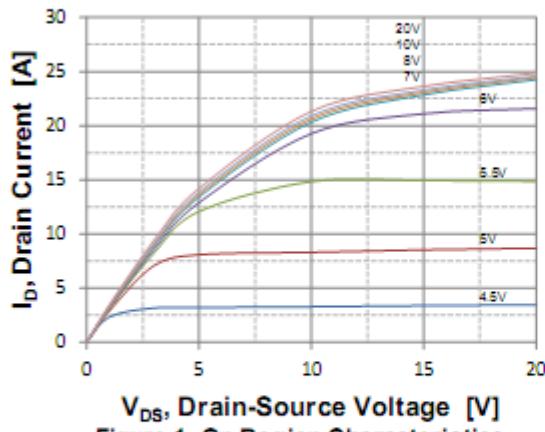
Electrical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
On-Characteristics						
V_{GS}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$	2.0		4.0	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}$, $I_D = 5.5 \text{ A}$		0.34	0.38	Ω
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}$, $I_D = 1 \text{ mA}$	700			V
$I_{DS(on)}$	Zero Gate Voltage Drain Current	$V_{DS} = 700 \text{ V}$, $V_{GS} = 0$			1	μA
		$V_{DS} = 700 \text{ V}$, $T_C = 150^\circ\text{C}$			100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS} = \pm 30 \text{ V}$, $V_{DS} = 0 \text{ V}$			± 1	μA
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS} = 400 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1.0 \text{ MHz}$		1100		pF
C_{oss}	Output Capacitance			29		pF
C_{rss}	Reverse Transfer Capacitance			3.8		pF
Switching Characteristics						
$t_{d(on)}$	Turn-On Time	$V_{DS} = 325 \text{ V}$, $I_D = 5.7 \text{ A}$, $R_G = 25 \Omega$ (Note 3,4)		30		ns
t_r	Turn-On Rise Time			20		ns
$t_{d(off)}$	Turn-Off Delay Time			125		ns
t_f	Turn-Off Fall Time			17		ns
Q_g	Total Gate Charge	$V_{DS} = 520 \text{ V}$, $I_D = 5.7 \text{ A}$, $V_{GS} = 10 \text{ V}$ (Note 3,4)		25		nC
Q_{gs}	Gate-Source Charge			5.8		nC
Q_{gd}	Gate-Drain Charge			9.2		nC
Drain-Source Diode Characteristics and Maximum Ratings						
I_S	Maximum Continuous Drain-Source Diode Forward Current				11	A
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current				33	A
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}$, $I_S = 11 \text{ A}$			1.3	V
trr	Reverse Recovery Time	$V_R = 400 \text{ V}$, $I_F = 5.7 \text{ A}$ $di_F/dt = 100 \text{ A}/\mu\text{s}$		250		ns
Qrr	Reverse Recovery Charge			2.6		μC

Notes :

- Repetitive Rating : Pulse width limited by maximum junction temperature
- $I_{AS}=1.75\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_J = 25^\circ\text{C}$
- Pulse Test : Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2\%$
- Essentially Independent of Operating Temperature

Typical Characteristics



Typical Characteristics (continued)

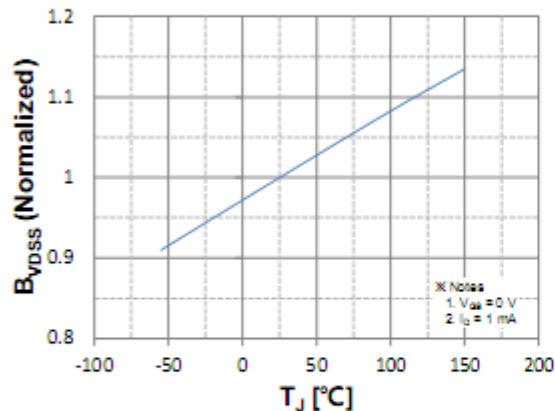


Figure 7. Breakdown Voltage Variation
vs. Temperature

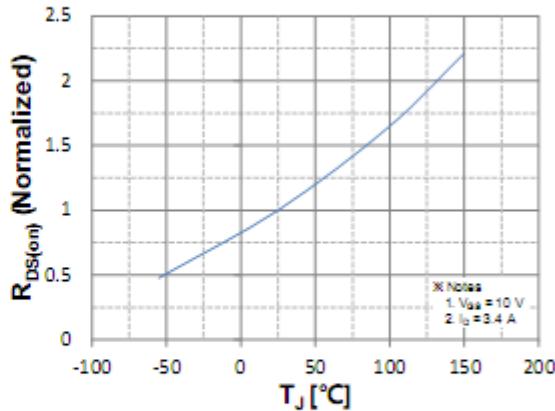


Figure 8. On-Resistance Variation
vs. Temperature

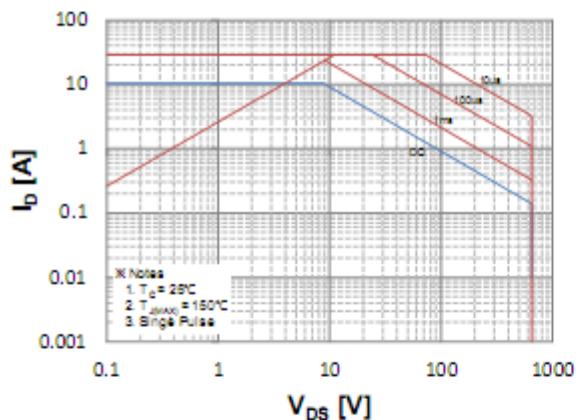


Figure 9. Maximum Safe Operating Area

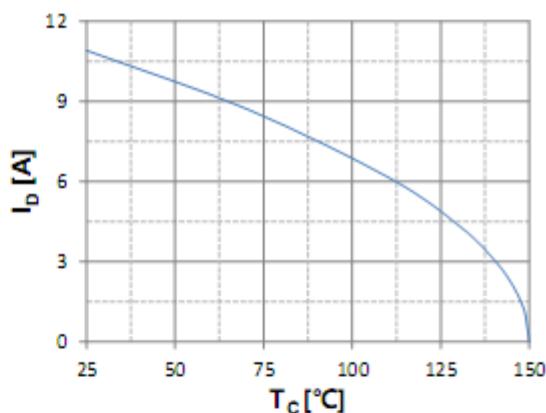


Figure 10. Maximum Drain Current
vs. Case Temperature

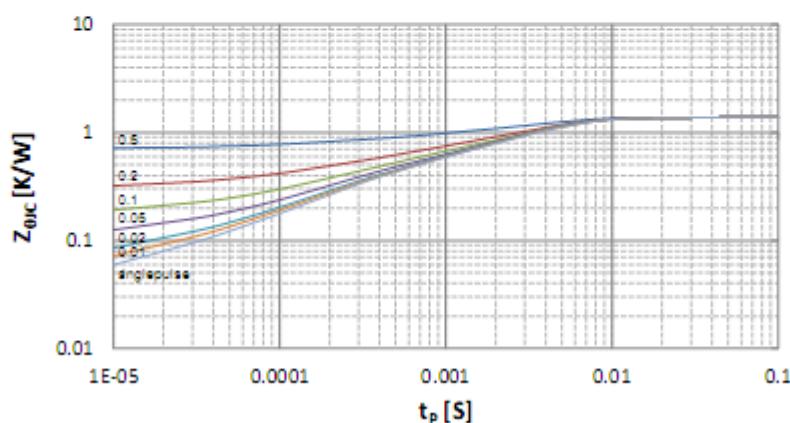


Figure 11. Transient Thermal Response Curve

Fig 12. Gate Charge Test Circuit & Waveform

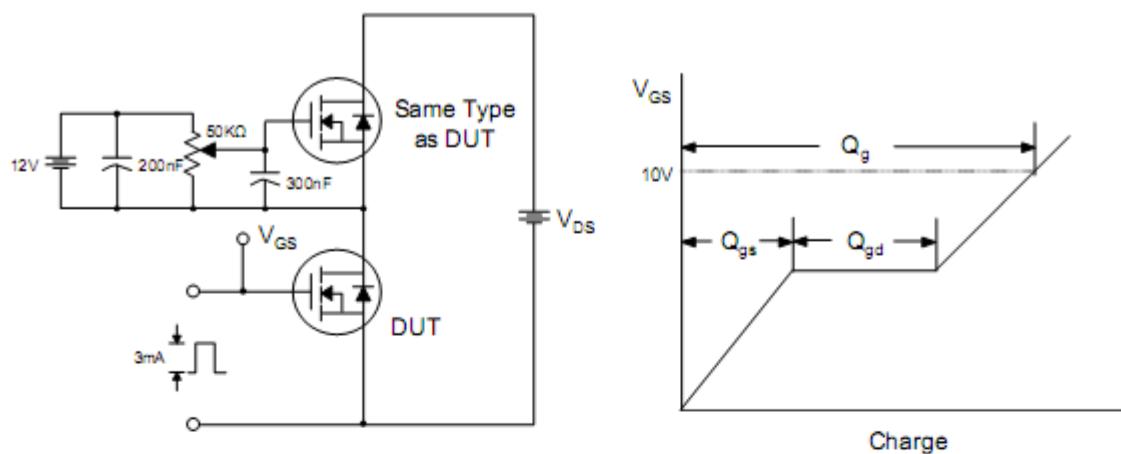


Fig 13. Resistive Switching Test Circuit & Waveforms

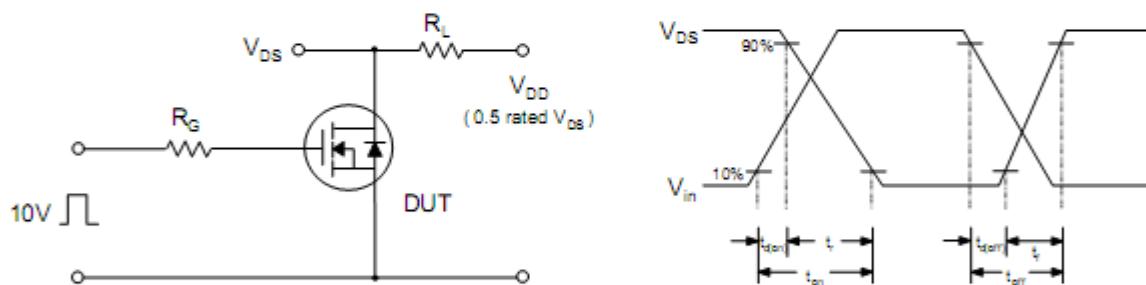


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

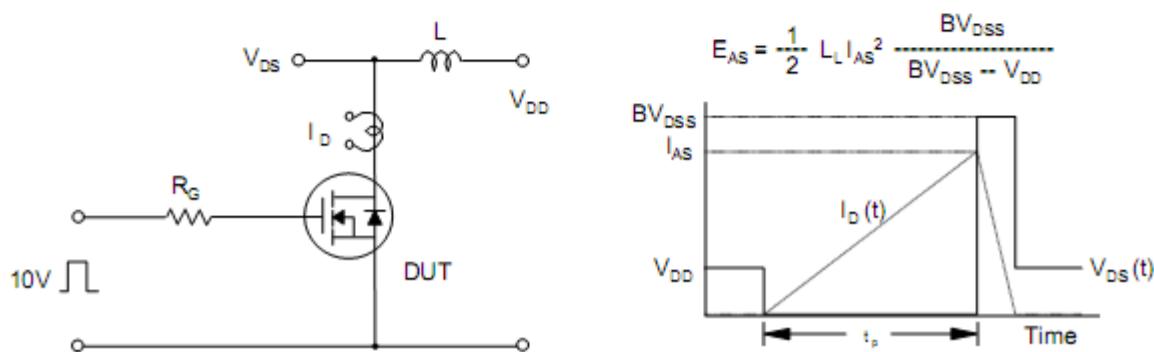
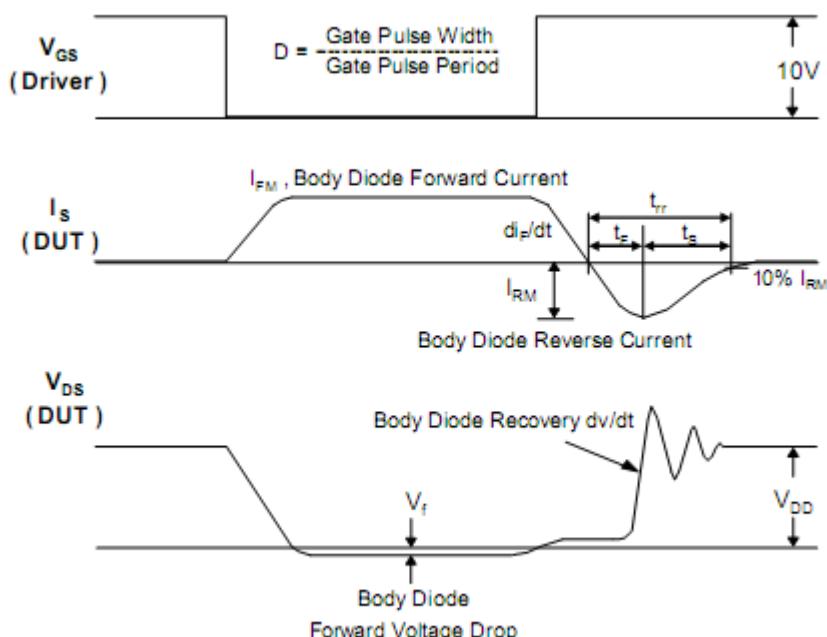
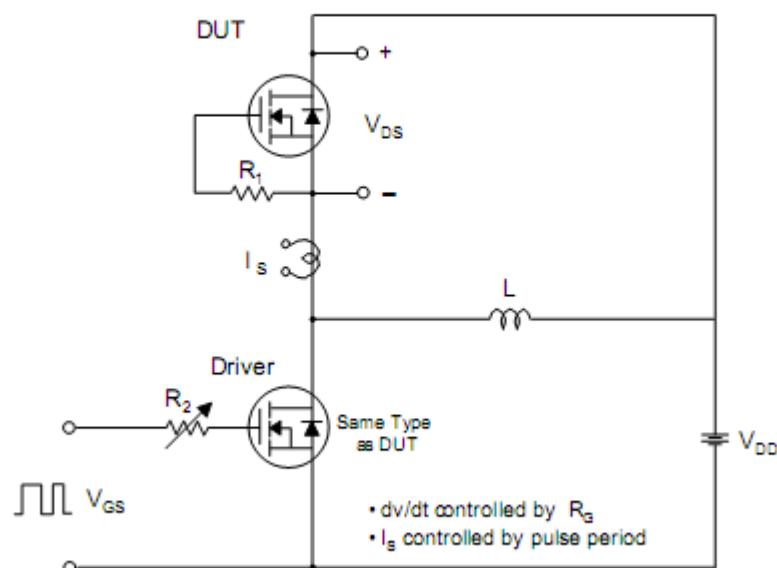


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



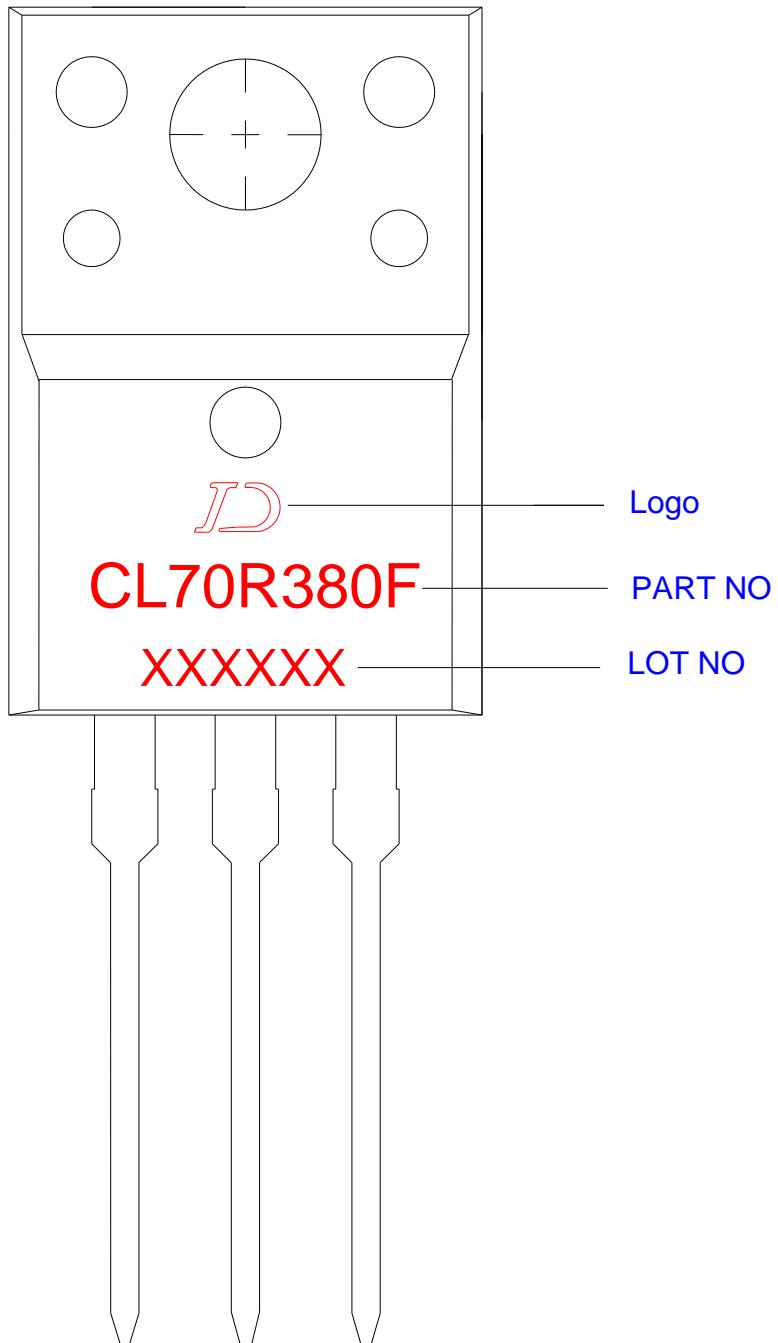


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Marking





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Package Dimension (Unit: mm)

TO-220F

